Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

ON Semiconductor MMJT9435T1

For any questions, you can email us directly: sales@integrated-circuit.com

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



MMJT9435

Preferred Device

Bipolar Power Transistors

PNP Silicon

Features

- Pb-Free Packages are Available
- Collector Emitter Sustaining Voltage -

$$V_{CEO(sus)} = 30 \text{ Vdc (Min)} @ I_C = 10 \text{ mAdc}$$

• High DC Current Gain -

$$h_{FE}$$
 = 125 (Min) @ I_C = 0.8 Adc
= 90 (Min) @ I_C = 3.0 Adc

• Low Collector -Emitter Saturation Voltage -

$$V_{CE(sat)} = 0.275 \text{ Vdc (Max)} @ I_C = 1.2 \text{ Adc}$$

= 0.55 Vdc (Max) @ I_C = 3.0 Adc

- SOT-223 Surface Mount Packaging
- Epoxy Meets UL 94, V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B; > 8000 V Machine Model, C; > 400 V



ON Semiconductor®

http://onsemi.com

POWER BJT $I_C = 3.0$ AMPERES $BV_{CEO} = 30$ VOLTS $V_{CE(sat)} = 0.275$ VOLTS



MARKING DIAGRAM



SOT-223 CASE 318E STYLE 1



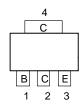
9435

= Specific Device Code

WW

= Assembly Location= Work Week

PIN ASSIGNMENT



Top View Pinout

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

Distributor of ON Semiconductor: Excellent Integrated System Limited

Datasheet of MMJT9435T1 - TRANS PNP 30V 3A SOT223

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

MMJT9435

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	30	Vdc
Collector-Base Voltage	V _{CB}	45	Vdc
Emitter-Base Voltage	V _{EB}	6.0	Vdc
Base Current – Continuous	I _B	1.0	Adc
Collector Current – Continuous – Peak	I _C	3.0 5.0	Adc
Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate above 25°C Total P_D @ $T_A = 25^{\circ}C$ mounted on 1" sq. (645 sq. mm) Collector pad on FR-4 bd material Total P_D @ $T_A = 25^{\circ}C$ mounted on 0.012" sq. (7.6 sq. mm) Collector pad on FR-4 bd material	P _D	3.0 24 1.56 0.72	W mW/°C W
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction–to–Case – Junction–to–Ambient on 1" sq. (645 sq. mm) Collector pad on FR–4 bd material – Junction–to–Ambient on 0.012" sq. (7.6 sq. mm) Collector pad on FR–4 bd material	$egin{array}{l} R_{ heta JC} \ R_{ heta JA} \ R_{ heta JA} \end{array}$	42 80 174	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C

ORDERING INFORMATION

Device	Package	Shipping [†]
MMJT9435T1	SOT-223	1000 / Tape & Reel
MMJT9435T1G	SOT-223 (Pb-Free)	1000 / Tape & Reel
MMJT9435T3	SOT-223	4000 / Tape & Reel
MMJT9435T3G	SOT-223 (Pb-Free)	4000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MMJT9435

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u> </u>	•	'	•	•
Collector–Emitter Sustaining Voltage (I _C = 10 mAdc, I _B = 0 Adc)	V _{CEO(sus)}	30	-	-	Vdc
Emitter–Base Voltage (I _E = 50 μAdc, I _C = 0 Adc)	V _{EBO}	6.0	_	-	Vdc
Collector Cutoff Current $ (V_{CE} = 25 \text{ Vdc}, R_{BE} = 200 \ \Omega) $ $ (V_{CE} = 25 \text{ Vdc}, R_{BE} = 200 \ \Omega, T_{J} = 125^{\circ}\text{C}) $	I _{CER}	_ _	- -	20 200	μAdc
Emitter Cutoff Current (V _{BE} = 5.0 Vdc)	I _{EBO}	-	-	10	μAdc
ON CHARACTERISTICS (Note 1)					
Collector–Emitter Saturation Voltage ($I_C = 0.8$ Adc, $I_B = 20$ mAdc) ($I_C = 1.2$ Adc, $I_B = 20$ mAdc) ($I_C = 3.0$ Adc, $I_B = 0.3$ Adc)	V _{CE(sat)}	- - -	0.155 _ _	0.210 0.275 0.550	Vdc
Base–Emitter Saturation Voltage (I _C = 3.0 Adc, I _B = 0.3 Adc)	V _{BE(sat)}	-	-	1.25	Vdc
Base–Emitter On Voltage ($I_C = 1.2 \text{ Adc}, V_{CE} = 4.0 \text{ Vdc}$)	V _{BE(on)}	-	_	1.10	Vdc
DC Current Gain $ \begin{aligned} &(I_C=0.8 \text{ Adc, V}_{CE}=1.0 \text{ Vdc}) \\ &(I_C=1.2 \text{ Adc, V}_{CE}=1.0 \text{ Vdc}) \\ &(I_C=3.0 \text{ Adc, V}_{CE}=1.0 \text{ Vdc}) \end{aligned} $	h _{FE}	125 110 90	220 _ _	- - -	-
DYNAMIC CHARACTERISTICS					
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0 Adc, f = 1.0 MHz)	C _{ob}	_	100	150	pF
Input Capacitance (V _{EB} = 8.0 Vdc)	C _{ib}	-	135	-	pF
Current–Gain – Bandwidth Product (Note 2) (I _C = 500 mA, V _{CE} = 10 V, F _{test} = 1.0 MHz)	f _T	-	110	-	MHz

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.

^{2.} $f_T = |h_{FE}| \cdot f_{test}$

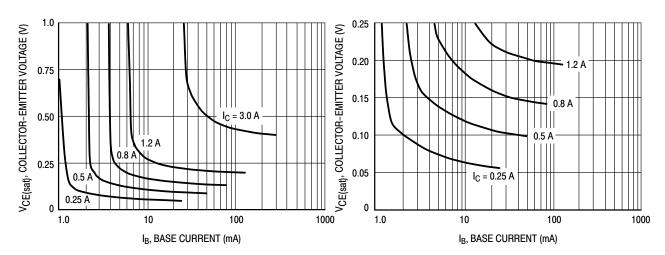


Figure 1. Collector Saturation Region

Figure 2. Collector Saturation Region

MMJT9435

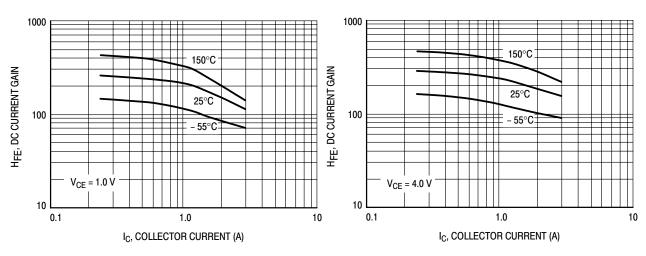


Figure 3. DC Current Gain

Figure 4. DC Current Gain

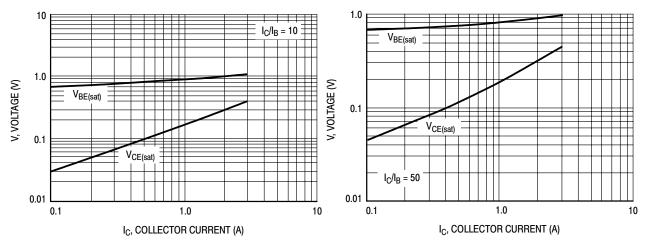


Figure 5. "On" Voltages

Figure 6. "On" Voltages

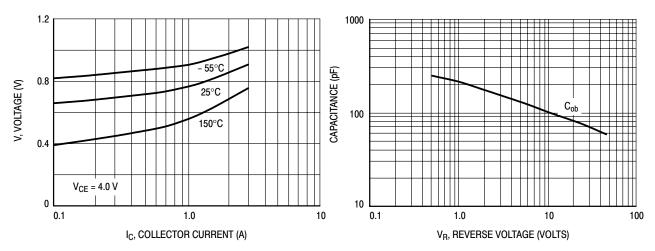


Figure 7. V_{BE(on)} Voltage

Figure 8. Output Capacitance

MMJT9435

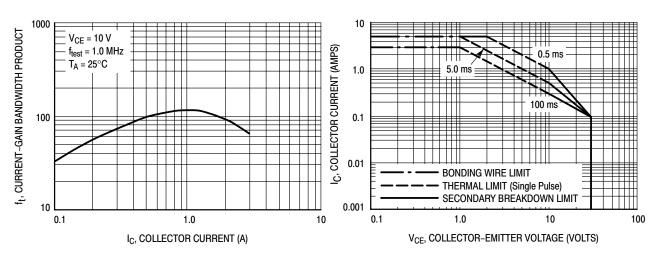


Figure 9. Current-Gain Bandwidth Product

Figure 10. Active Region Safe Operating Area

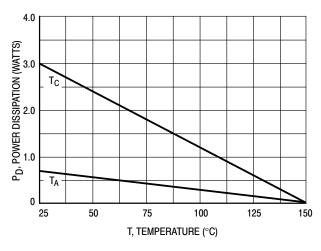


Figure 11. Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and secondary breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 10 is based on $T_{J(pk)} = 150^{\circ}C$; T_C is variable depending on conditions. Secondary breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 12. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by secondary breakdown.

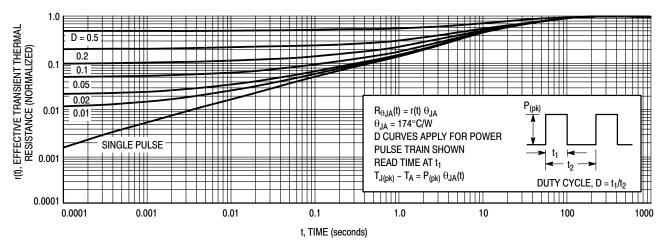


Figure 12. Thermal Response



Distributor of ON Semiconductor: Excellent Integrated System Limited

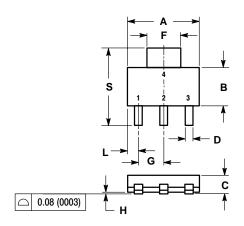
Datasheet of MMJT9435T1 - TRANS PNP 30V 3A SOT223

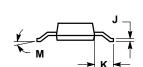
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

MMJT9435

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 **ISSUE K**





- DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: INCH.

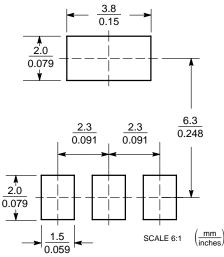
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.249	0.263	6.30	6.70
В	0.130	0.145	3.30	3.70
С	0.060	0.068	1.50	1.75
D	0.024	0.035	0.60	0.89
F	0.115	0.126	2.90	3.20
G	0.087	0.094	2.20	2.40
Н	0.0008	0.0040	0.020	0.100
J	0.009	0.014	0.24	0.35
K	0.060	0.078	1.50	2.00
L	0.033	0.041	0.85	1.05
M	0 °	10 °	0 °	10°
S	0.264	0.287	6.70	7.30

STYLE 1: PIN 1. BASE

2. COLLECTOR 3. EMITTER

COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patient rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should be supported to the SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082–1312 USA

Phone: 480–829–7710 or 800–344–3860 Toll Free USA/Canada Fax: 480-829-7709 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Japan: ON Semiconductor, Japan Customer Focus Center 2–9–1 Kamimeguro, Meguro–ku, Tokyo, Japan 153–0051 **Phone**: 81–3–5773–3850 ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative